Preferred Device

Advance Information

Power MOSFET 10 Amps, 400 Volts

N-Channel TO-220 and D2PAK

Designed for high voltage, high speed switching applications in power supplies, converters, power motor controls and bridge circuits.

Features

- Higher Current Rating
- Lower RDS(on)
- Lower Capacitances
- Lower Total Gate Charge
- Tighter V_{SD} Specifications
- Avalanche Energy Specified

Typical Applications

- Switch Mode Power Supplies
- PWM Motor Controls
- Converters
- Bridge Circuits

MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	400	Vdc
Drain–Gate Voltage (RGS = 1.0 M Ω)	V _{DGR}	400	Vdc
Gate–Source Voltage – Continuous – Non–Repetitive (tp≤10 ms)	V _{GS} V _{GSM}	±20 ±40	Vdc
Drain - Continuous - Continuous @ 100°C - Single Pulse (t _p ≤ 10 μs)	ID ID IDM	10 7.5 35	Adc
Total Power Dissipation Derate above 25°C	PD	142 1.14	Watts W/°C
Operating and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C
Single Drain-to-Source Avalanche Energy – Starting T _J = 25°C (V _{DD} = 100 Vdc, V _{GS} = 10 Vdc, I _L = 10 A, L = 10 mH, R _G = 25 Ω)	EAS	500	mJ
Thermal Resistance – Junction–to–Case – Junction–to–Ambient – Junction–to–Ambient (Note 1.)	$R_{\theta JC}$ $R_{\theta JA}$ $R_{\theta JA}$	0.88 62.5 50	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	TL	260	°C

When surface mounted to an FR4 board using the minimum recommended pad size.

his document contains information on a new product. Specifications and information

in are subject to change without notice.

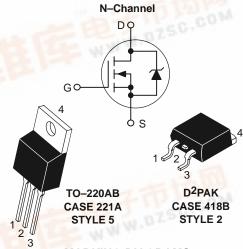


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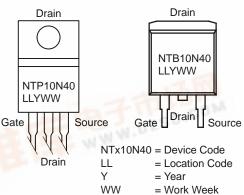
http://onsemi.com

10 AMPERES **400 VOLTS**

RDS(on) = 500 m Ω



MARKING DIAGRAMS AND PIN ASSIGNMENTS



ORDERING INFORMATION

Device	Package	Shipping
NTP10N40	TO-220AB	50 Units/Rail
NTB10N40	D ² PAK	50 Units/Rail
NTB10N40T4	D ² PAK	800/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

dzsc.com

ELECTRICAL CHARACTERISTICS ($T_C = 25$ °C unless otherwise noted)

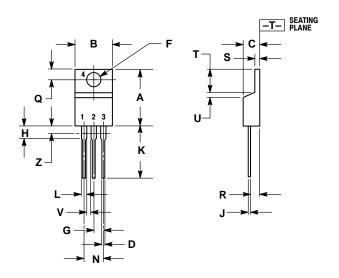
Ch	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Vo (V _{GS} = 0 Vdc, I _D = 0.25 mAc	V _{(BR)DSS}	400	_	-	Vdc	
Temperature Coefficient (Pos		-	475	-	mV/°C	
Zero Gate Voltage Collector Cu $(V_{DS} = 400 \text{ Vdc}, V_{GS} = 0 \text{ Vol})$ $(V_{DS} = 400 \text{ Vdc}, V_{GS} = 0 \text{ Vol})$	IDSS	<u>-</u>	_ _	10 100	μAdc	
Gate-Body Leakage Current (V	IGSS(f) IGSS(r)	_ _	_ _	100 100	nAdc	
ON CHARACTERISTICS (Note 2	2.)					
Gate Threshold Voltage ID = 0.25 mA, VDS = VGS Temperature Coefficient (Neg	VGS(th)	2.0	2.5 6.5	4.0 -	Vdc mV/°C	
Static Drain-to-Source On-Res	sistance (V _{GS} = 10 Vdc, I _D = 5.0 Adc)	R _{DS(on)}	_	350	500	mOhm
Drain-to-Source On-Voltage (V _{GS} = 10 Vdc, I _D = 10 Adc) (V _{GS} = 10 Vdc, I _D = 5.0 Adc)	V _{DS(on)}	1 1	_ _	6.0 5.3	Vdc	
Forward Transconductance (VD		9FS	2.0	7.0	_	Mhos
DYNAMIC CHARACTERISTICS	, , , , , , , , , , , , , , , , , , , ,	01.0				
Input Capacitance		C _{iss}	_	1440	2020	pF
Output Capacitance	$(V_{DS} = 25 \text{ Vdc}, V_{GS} = 0 \text{ Vdc},$	C _{oss}	_	360	500	'
Transfer Capacitance	f = 1.0 MHz)	C _{rss}	_	15	30	
SWITCHING CHARACTERISTIC	S (Note 3.)			1		
Turn-On Delay Time		t _{d(on)}	_	10	20	ns
Rise Time	$(V_{DD} = 200 \text{ Vdc}, I_D = 10 \text{ Adc},$	t _r	_	20	40	
Turn-Off Delay Time	$V_{GS} = 10 \text{ Vdc},$ $R_{G} = 9.1 \Omega)$	t _d (off)	_	33	70	
Fall Time		t _f	1	24	50	
Gate Charge	(V _{DS} = 320 Vdc, I _D = 10 Adc,	Q _T	-	24	30	nC
		Q ₁	_	6.0	-	
	V _{GS} = 10 Vdc)	Q ₂	_	7.0	-	
		Q ₃	1	12	-	
SOURCE-DRAIN DIODE CHAR	ACTERISTICS					
Forward On–Voltage (Note 2.)	(I _S = 10 Adc, V _{GS} = 0 Vdc) (I _S = 10 Adc, V _{GS} = 0 Vdc, T _J = 125°C)	V _{SD}		0.9 0.8	1.1 -	Vdc
Reverse Recovery Time		t _{rr}	-	305	_	ns
	4 40 4 1 14 0 14 1	t _a	-	155	_	1
	$(I_S = 10 \text{ Adc}, V_{GS} = 0 \text{ Vdc}, \\ dI_S/dt = 100 \text{ A/}\mu\text{s})$	t _b	1	150	-	
Reverse Recovery Stored Charge		Q _{RR}	ı	2.5	-	μС
NTERNAL PACKAGE INDUCTA	NCE					
Internal Drain Inductance (Measured from contact screw on tab to center of die) (Measured from the drain lead 0.25" from package to center of die)		LD	- -	3.5 4.5	- -	nH
Internal Source Inductance (Measured from the source lea	LS	_	7.5	_		

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperature.

PACKAGE DIMENSIONS

TO-220 THREE-LEAD TO-220AB

CASE 221A-09 **ISSUE AA**



NOTES:

- NOTES:

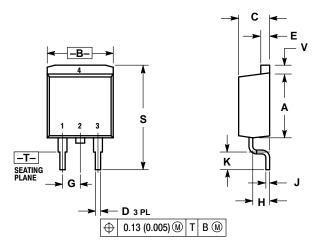
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCH.

 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INC	HES	MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
7	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

- STYLE 5:
 PIN 1. GATE
 2. DRAIN
 3. SOURCE
 4. DRAIN
- D²PAK CASE 418B-03 ISSUE D



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

	INC	HES	MILLIM	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.340	0.380	8.64	9.65
В	0.380	0.405	9.65	10.29
С	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
G	0.100 BSC		2.54 BSC	
Н	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
K	0.090	0.110	2.29	2.79
S	0.575	0.625	14.60	15.88
v	0.045	0.055	1 14	1 40

STYLE 2: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN

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